

### Description

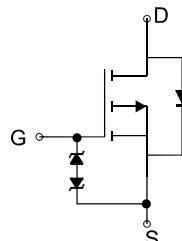
The HM50P35DE uses advanced trench technology to provide excellent  $R_{DS(ON)}$ . This device is suitable for use as a load switch or power management.

### General Features

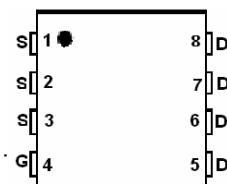
- $V_{DS} = -35V, I_D = -50A$
- $R_{DS(ON)} < 7.2m\Omega @ V_{GS} = -10V$
- High power and current handing capability
- Lead free product is acquired
- Surface mount package

### Application

- Power management
- Load switch



Schematic diagram



Marking and pin assignment

### Package Marking and Ordering Information

| Device Marking | Device    | Device Package | Reel Size | Tape width | Quantity  |
|----------------|-----------|----------------|-----------|------------|-----------|
| HM50P35DE      | HM50P35DE | DFN5X6-8L      | Ø330mm    | 12mm       | 500 units |

### Absolute Maximum Ratings ( $T_A=25^\circ C$ unless otherwise noted)

| Parameter  | Symbol         | Limit      | Unit |
|--|----------------|------------|------|
| Drain-Source Voltage                             | $V_{DS}$       | -35        | V    |
| Gate-Source Voltage                              | $V_{GS}$       | $\pm 20$   | V    |
| Drain Current-Continuous                         | $I_D$          | -50        | A    |
| Drain Current-Pulsed <sup>(Note 1)</sup>         | $I_{DM}$       | -150       | A    |
| Maximum Power Dissipation                        | $P_D$          | 75         | W    |
| Operating Junction and Storage Temperature Range | $T_J, T_{STG}$ | -55 To 150 | °C   |

### Thermal Characteristic

|   |                 |    |      |
|---|-----------------|----|------|
| Thermal Resistance, Junction-to-Ambient <sup>(Note 2)</sup> | $R_{\theta JA}$ | 36 | °C/W |
|---|-----------------|----|------|

### Electrical Characteristics ( $T_A=25^\circ C$ unless otherwise noted)

| Parameter                       | Symbol     | Condition                  | Min | Typ | Max | Unit    |
|---------------------------------|------------|----------------------------|-----|-----|-----|---------|
| <b>Off Characteristics</b>      |            |                            |     |     |     |         |
| Drain-Source Breakdown Voltage  | $BV_{DSS}$ | $V_{GS}=0V, I_D=-250\mu A$ | -35 | -33 | -   | V       |
| Zero Gate Voltage Drain Current | $I_{DSS}$  | $V_{DS}=-35V, V_{GS}=0V$   | -   | -   | -1  | $\mu A$ |

|  |                     |  |      |      |      |    |
|--|---------------------|--|------|------|------|----|
| Gate-Body Leakage Current                                | I <sub>GSS</sub>    | V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V                                     | -    | -    | ±100 | nA |
| <b>On Characteristics</b> <small>(Note 3)</small>        |                     |  |      |      |      |    |
| Gate Threshold Voltage                                   | V <sub>GS(th)</sub> | V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =-250μA                      | -1.0 | -    | -3.0 | V  |
| Drain-Source On-State Resistance                         | R <sub>DS(ON)</sub> | V <sub>GS</sub> =-10V, I <sub>D</sub> =-30A                                    | -    | 5.5  | 7.2  | mΩ |
| Forward Transconductance                                 | g <sub>FS</sub>     | V <sub>DS</sub> =-10V, I <sub>D</sub> =-30A                                    | 30   | -    | -    | S  |
| <b>Dynamic Characteristics</b> <small>(Note 4)</small>   |                     |  |      |      |      |    |
| Input Capacitance  | C <sub>iss</sub>    | V <sub>DS</sub> =-15V, V <sub>GS</sub> =0V,<br>F=1.0MHz                        | -    | 3960 | -    | PF |
| Output Capacitance                                       | C <sub>oss</sub>    |  | -    | 486  | -    | PF |
| Reverse Transfer Capacitance                             | C <sub>rss</sub>    |  | -    | 268  | -    | PF |
| <b>Switching Characteristics</b> <small>(Note 4)</small> |                     |  |      |      |      |    |
| Turn-on Delay Time                                       | t <sub>d(on)</sub>  | V <sub>DD</sub> =-15V, ID=-20A,<br>V <sub>GS</sub> =-10V, R <sub>GEN</sub> =3Ω | -    | 20   | -    | nS |
| Turn-on Rise Time  | t <sub>r</sub>      |  | -    | 13   | -    | nS |
| Turn-Off Delay Time                                      | t <sub>d(off)</sub> |  | -    | 55   | -    | nS |
| Turn-Off Fall Time                                       | t <sub>f</sub>      |  | -    | 21   | -    | nS |
| Total Gate Charge  | Q <sub>g</sub>      | V <sub>DS</sub> =-15V, I <sub>D</sub> =-20A, V <sub>GS</sub> =-10V             | -    | 65   | -    | nC |
| Gate-Source Charge                                       | Q <sub>gs</sub>     |  | -    | 12   | -    | nC |
| Gate-Drain Charge  | Q <sub>gd</sub>     |  | -    | 14   | -    | nC |
| <b>Drain-Source Diode Characteristics</b>                |                     |  |      |      |      |    |
| Diode Forward Voltage <small>(Note 3)</small>            | V <sub>SD</sub>     | V <sub>GS</sub> =0V, I <sub>s</sub> =-50A                                      | -    | -    | -1.2 | V  |

### Notes

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, t ≤ 10 sec.
3. Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2%.
4. Guaranteed by design, not subject to production

### Typical Electrical and Thermal Characteristics

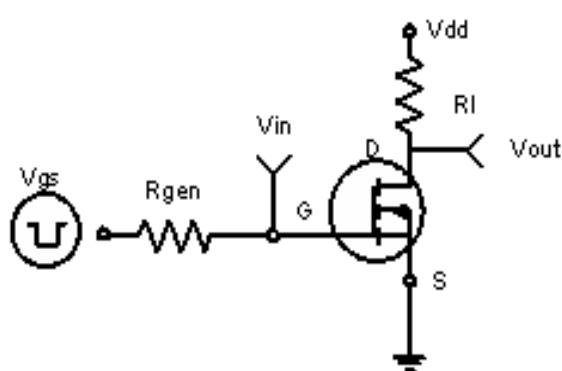


Figure 1 Switching Test Circuit

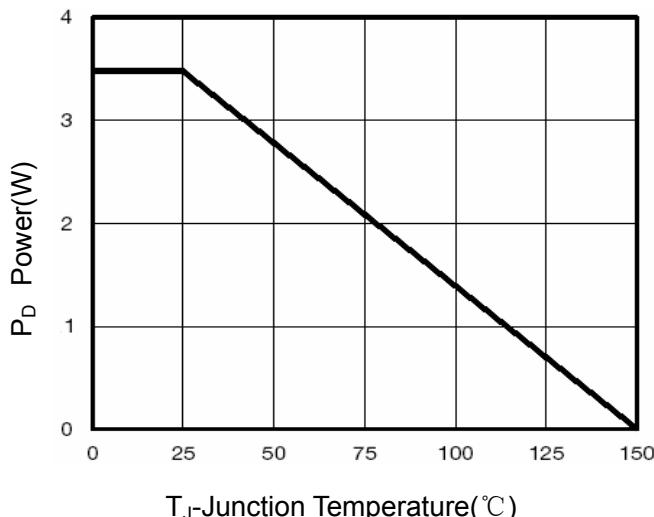


Figure 3 Power Dissipation

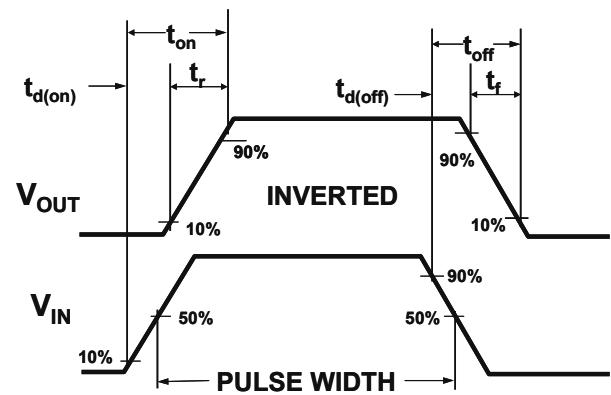


Figure 2 Switching Waveforms

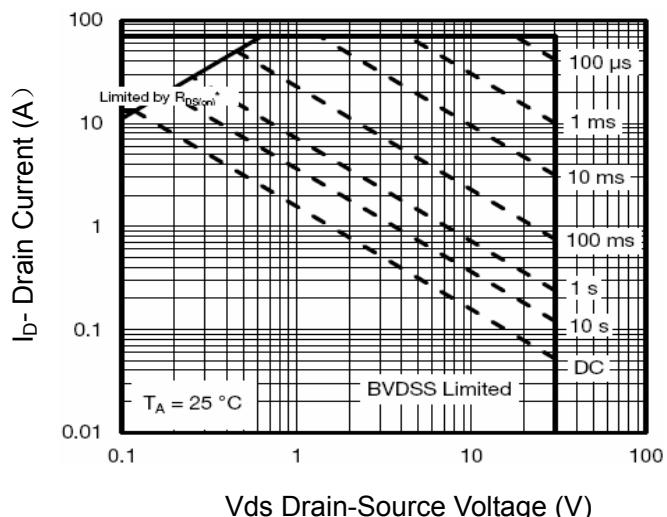


Figure 4 Safe Operation Area

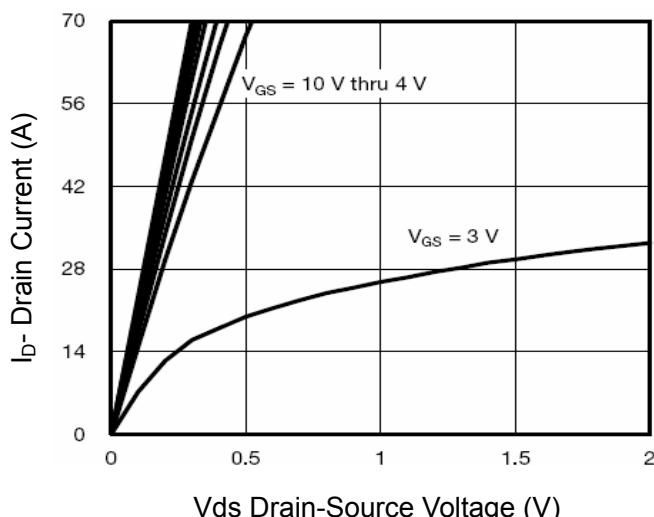


Figure 5 Output Characteristics

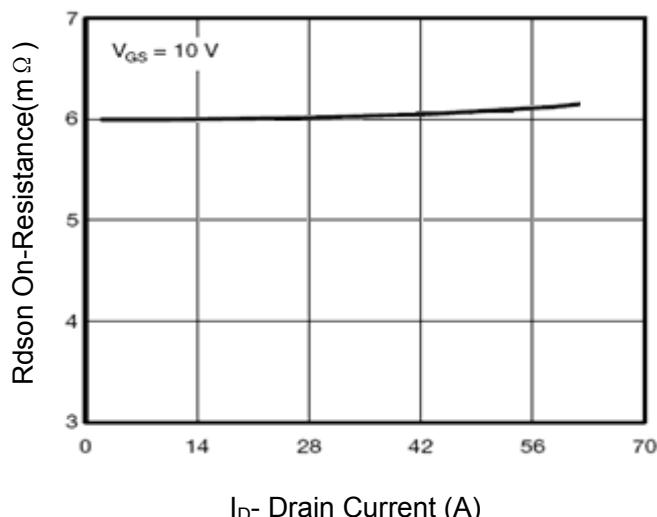


Figure 6 Drain-Source On-Resistance

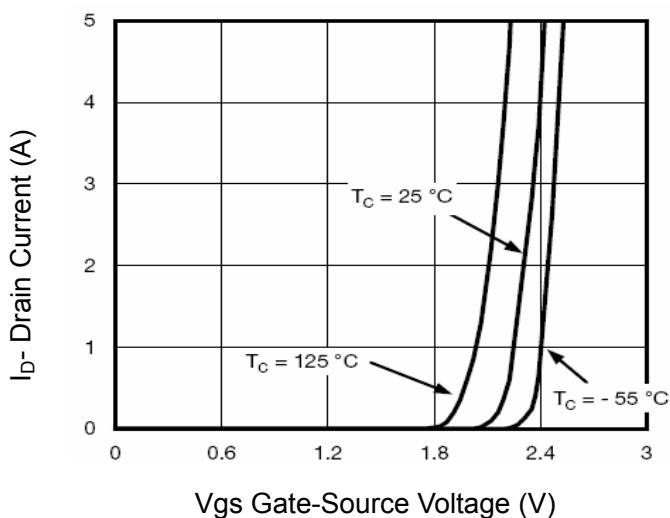


Figure 7 Transfer Characteristics

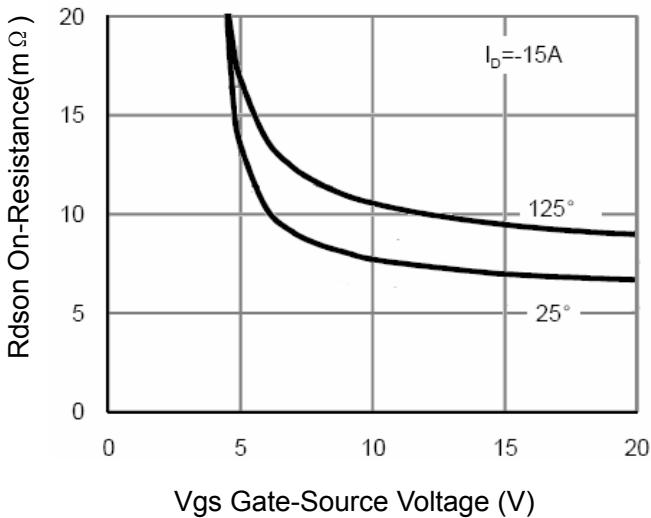


Figure 9  $R_{DS(on)}$  vs  $V_{GS}$

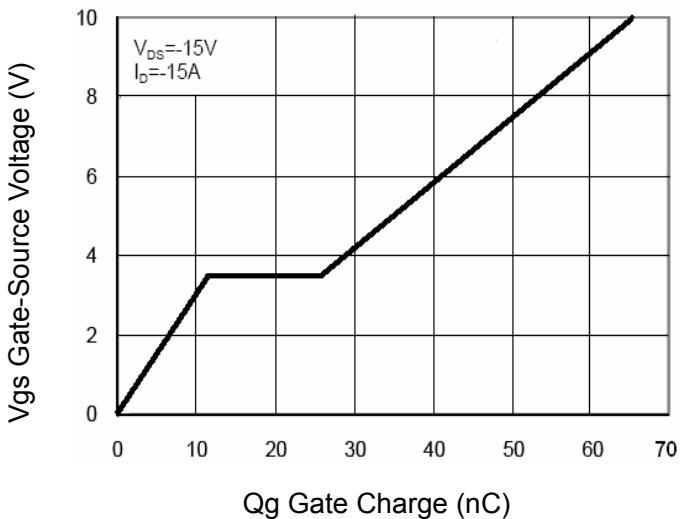


Figure 11 Gate Charge

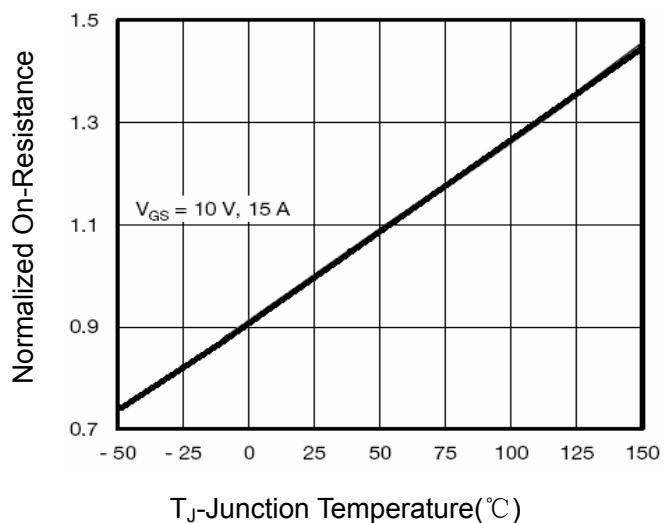


Figure 8 Drain-Source On-Resistance

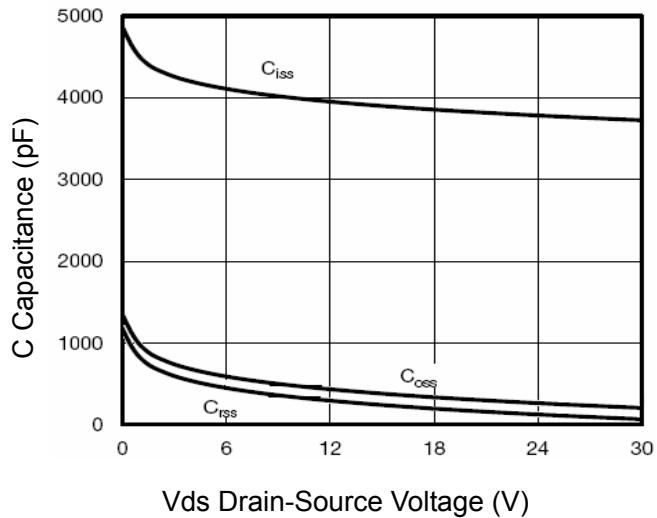


Figure 10 Capacitance vs  $V_{DS}$

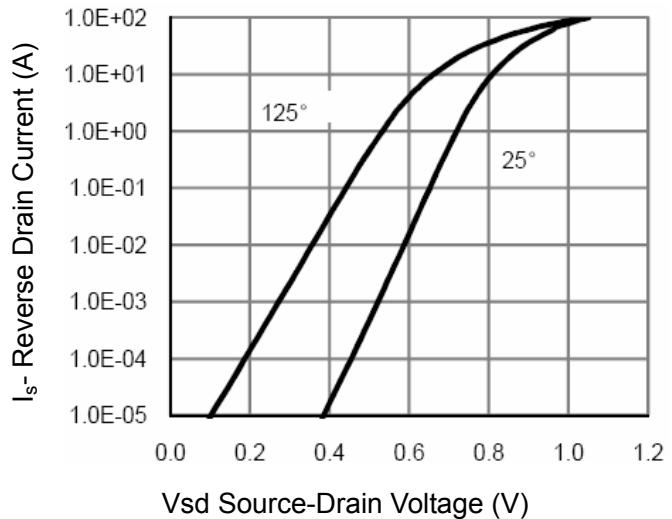


Figure 12 Source-Drain Diode Forward

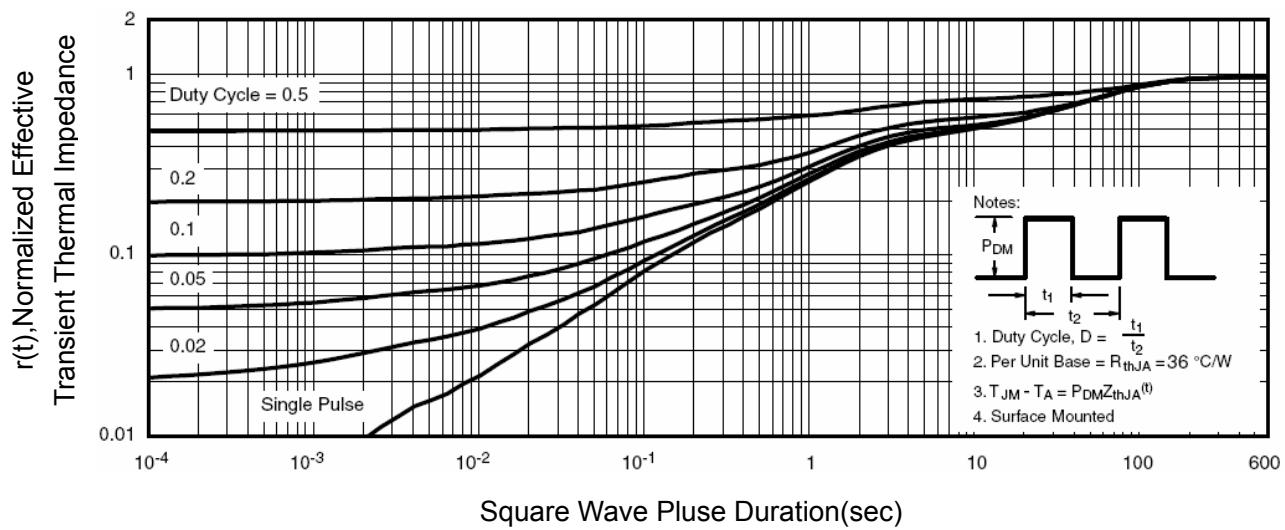
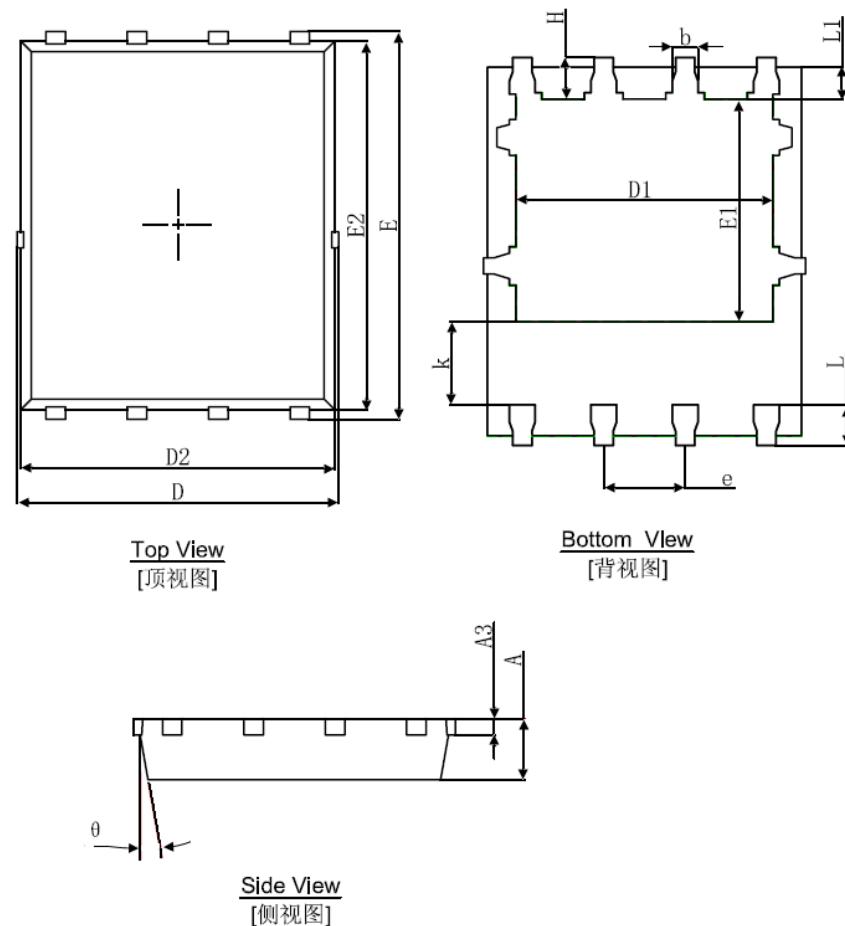


Figure 13 Normalized Maximum Transient Thermal Impedance

DFN5X6-8L Package Information



| Symbol | Dimensions In Millimeters |       | Dimensions In Inches |       |
|--------|---------------------------|-------|----------------------|-------|
|        | Min.                      | Max.  | Min.                 | Max.  |
| A      | 0.900                     | 1.000 | 0.035                | 0.039 |
| A3     | 0.254REF.                 |       | 0.010REF.            |       |
| D      | 4.944                     | 5.096 | 0.195                | 0.201 |
| E      | 5.974                     | 6.126 | 0.235                | 0.241 |
| D1     | 3.910                     | 4.110 | 0.154                | 0.162 |
| E1     | 3.375                     | 3.575 | 0.133                | 0.141 |
| D2     | 4.824                     | 4.976 | 0.190                | 0.196 |
| E2     | 5.674                     | 5.826 | 0.223                | 0.229 |
| K      | 1.190                     | 1.390 | 0.047                | 0.055 |
| b      | 0.035                     | 0.450 | 0.014                | 0.018 |
| e      | 1.270(TYP.)               |       | 0.050(TYP.)          |       |
| L      | 0.559                     | 0.711 | 0.022                | 0.028 |
| L1     | 0.424                     | 0.576 | 0.017                | 0.023 |
| H      | 0.574                     | 0.726 | 0.023                | 0.029 |
| θ      | 8°                        | 12°   | 8°                   | 12°   |